

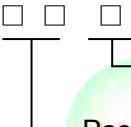


Single P-Channel, -12V, -6.5A, Power MOSFET

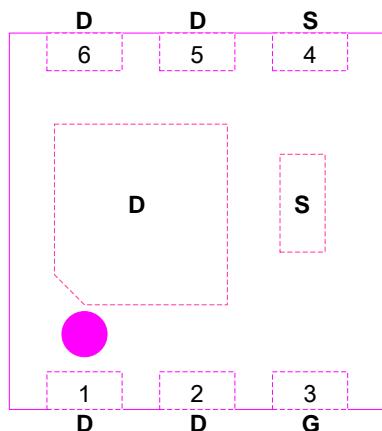
General Description

The LPM9021 is P-Channel enhancement MOSFET Effect Transistor. It uses advanced trench technology and design to provide excellent RDS (ON) with low gate charge. This device is suitable for using in DC-DC conversion, power switch and charging circuit. Standard Product LPM9021QVF is Pb-free and Halogen-free.

Order Information

LPM9021 □ □ □

 F: Pb-Free
 Package Type
 QV: DFN2*2-6L

Pin Configurations



Features

- Trench Technology
- Super high density cell design
- Excellent ON resistance for higher DC current
- Extremely Low Threshold Voltage
- Small package DFN2*2-6L

Applications

- ◊ Driver for Relay, Solenoid, Motor, LED etc.
- ◊ DC-DC converter circuit
- ◊ Power Switch
- ◊ Load Switch
- ◊ Charging

Marking Information

Device	Marking	Package	Shipping
LPM9021QVF		DFN2*2-6L	3K/REEL

Pin Description

Pin Number	Pin Description
1,2	Drain Pin
3	Gate Pin
4	Source Pin
5,6	Drain Pin



Absolute Maximum Ratings

Parameter		Symbol	10 S	Steady State	Unit
Drain-Source Voltage		VDS	-12	±12	V
Gate-Source Voltage		VGS	±12		
Continuous Drain Current	TA=25°C	ID	-6.5	-5.6	A
	TA=70°C		-5.2	-4.4	
Maximum Power Dissipation	TA=25°C	PD	1.9	1.4	W
	TA=70°C		1.2	0.9	
Continuous Drain Current	TA=25°C	ID	-4.8	-3.9	A
	TA=70°C		-3.8	-3.9	
Maximum Power Dissipation	TA=25°C	PD	1.0	0.6	W
	TA=70°C		0.6	0.4	
Pulsed Drain Current c		IDM	-24		A
Operating Junction Temperature		TJ	150		°C
Lead Temperature		TL	260		°C
Storage Temperature Range		Tstg	-55 to 150		°C

Thermal resistance ratings

Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance	t ≤10 s	R _{θJA}	49	64	°C/W
	Steady State		66	88	
Junction-to-Ambient Thermal Resistance	t ≤10 s	R _{θJA}	84	118	
	Steady State		125	180	
Junction-to-Case Thermal Resistance	Steady State	R _{θJC}	32	42	

a Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper

b Surface mounted on FR-4 board using minimum pad size, 1oz copper

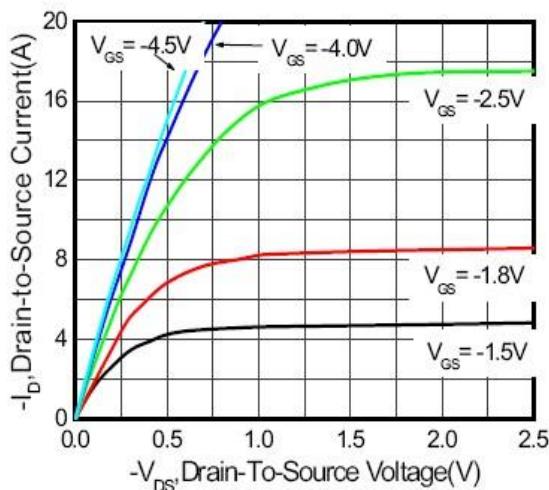
c Pulse width<380μs, Duty Cycle<2%

d Maximum junction temperature TJ=150°C.

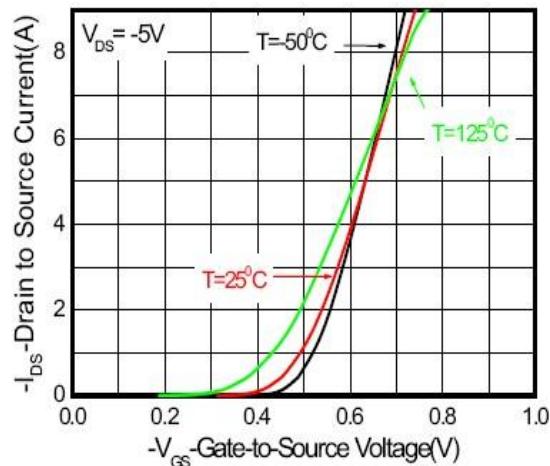


Electrical Characteristics

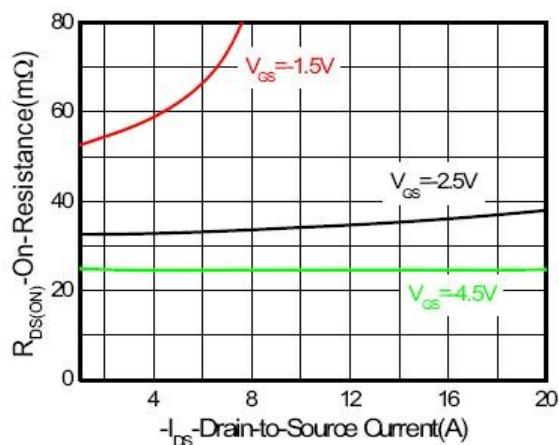
Parameter	Symbol	Test Condition	Min	Typ.	Max	Units
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0 \text{ V}, I_D = -250\mu\text{A}$	-12			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -12\text{V}, V_{GS} = 0\text{V}$			-1	μA
Gate-to-source Leakage Current	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = -12\text{V}$			± 100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$	-0.4	-0.52	-0.9	V
Drain-to-source On-resistance b, c	$R_{DS(on)}$	$V_{GS} = -4.5\text{V}, I_D = -5.5\text{A}$		23	29	$\text{m}\Omega$
		$V_{GS} = -2.5\text{V}, I_D = -2.5\text{A}$		30	39	
		$V_{GS} = -1.8\text{V}, I_D = -1.8\text{A}$		39	50	
		$V_{GS} = -1.5\text{V}, I_D = -1.5\text{A}$		48	90	
Forward Transconductance	g_{FS}	$V_{DS} = -5.0\text{V}, I_D = -5.5\text{A}$		23		S
CAPACITANCES, CHARGES						
Input Capacitance	C_{iss}	$V_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz}$ $V_{DS} = -10 \text{ V}$		1970		pF
Output Capacitance	C_{oss}			205		
Reverse Transfer Capacitance	C_{rss}			195		
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS} = -4.5 \text{ V},$ $V_{DS} = -10 \text{ V},$ $I_D = -6.5\text{A}$		21.0		nC
Threshold Gate Charge	$Q_{G(TH)}$			0.95		
Gate-to-Source Charge	Q_{GS}			1.30		
Gate-to-Drain Charge	Q_{GD}			7.60		
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$td(\text{ON})$	$V_{GS} = -4.5 \text{ V},$ $V_{DD} = -10 \text{ V},$ $I_D = -6.5\text{A},$ $R_G = 6 \text{ }\Omega$		16		ns
Rise Time	tr			15.5		
Turn-Off Delay Time	$td(\text{OFF})$			78		
Fall Time	tf			44		
BODY DIODE CHARACTERISTICS						
Forward Voltage	V_{SD}	$V_{GS} = 0 \text{ V}, I_S = -1.0\text{A}$	-	-0.76	1.5	V

Typical Characteristics ($T_a=25^\circ\text{C}$, unless otherwise noted)

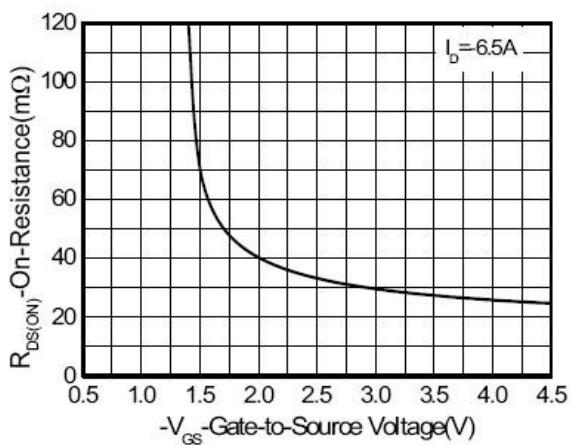
Output characteristics



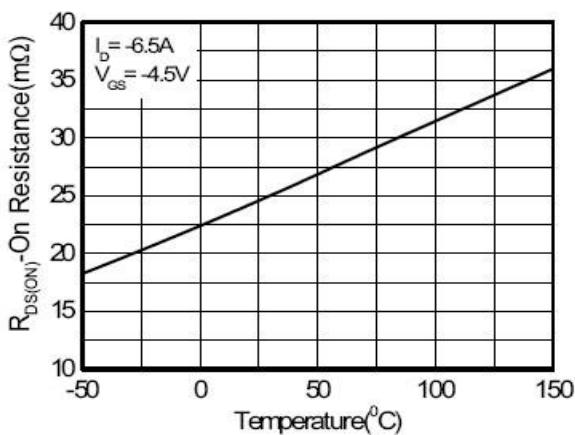
Transfer characteristics



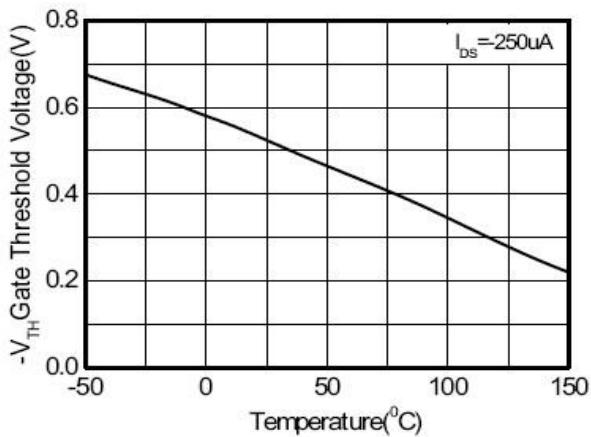
On-Resistance vs. Drain current



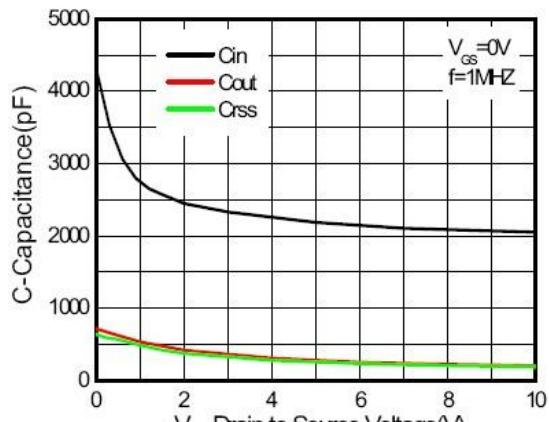
On-Resistance vs. Gate-to-Source voltage



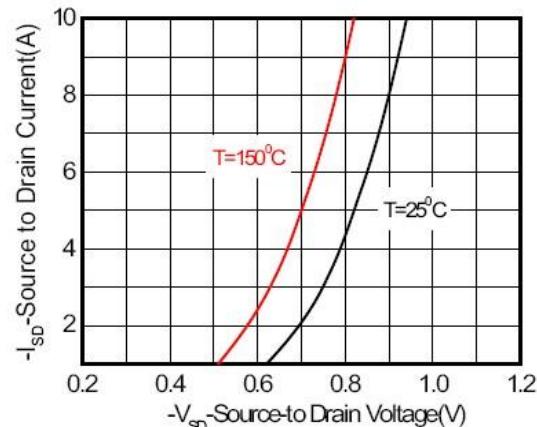
On-Resistance vs. Junction temperature



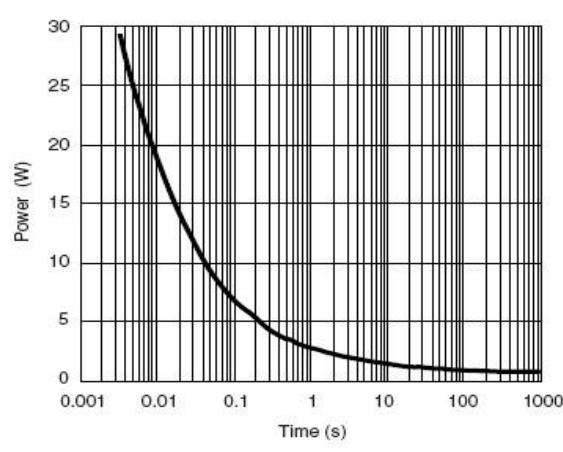
Threshold voltage vs. Temperature



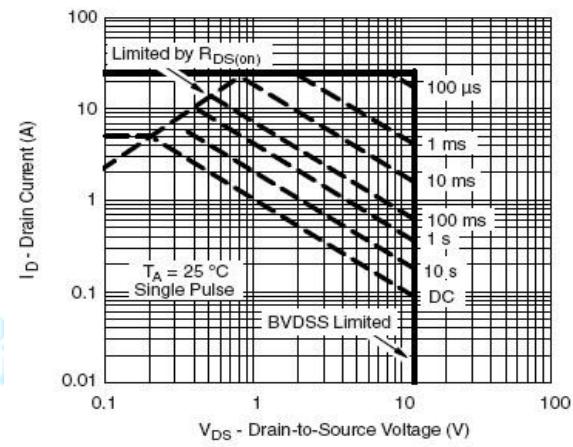
Capacitance



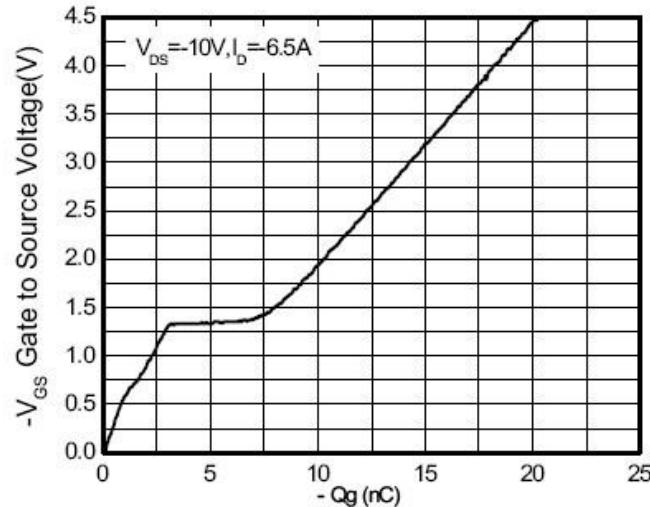
Body diode forward voltage



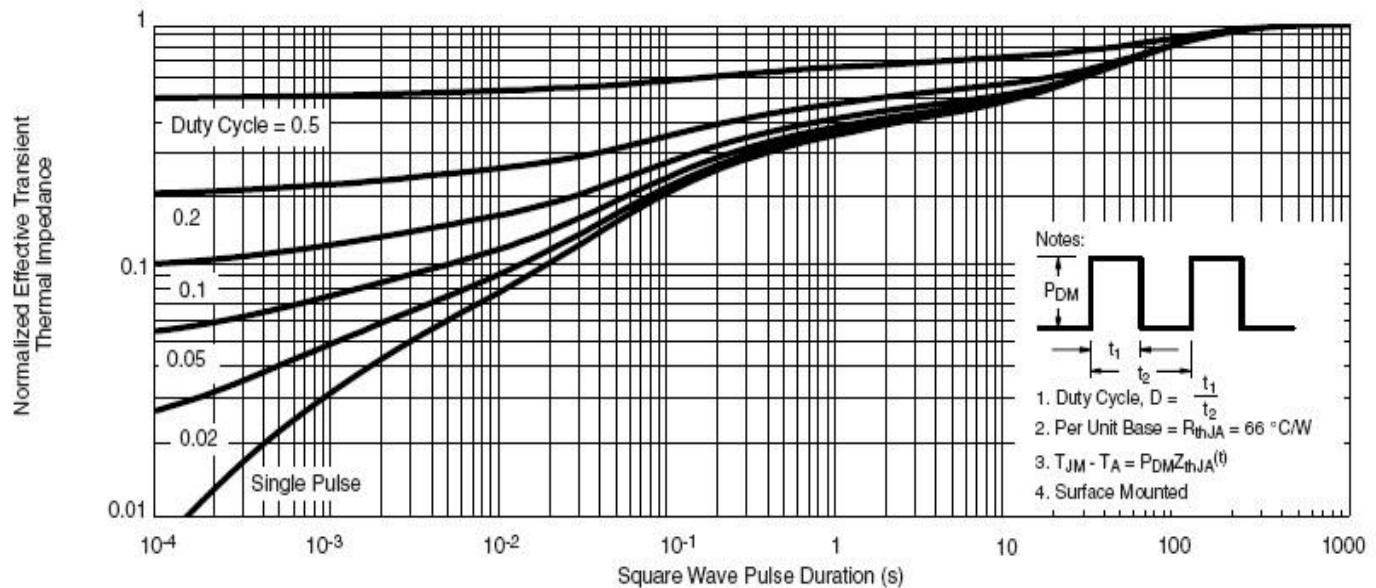
Single pulse power



Safe operating power



Gate Charge Characteristics

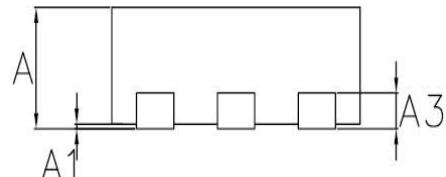
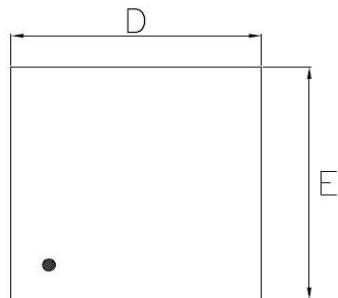


Transient thermal response (Junction-to-Ambient)



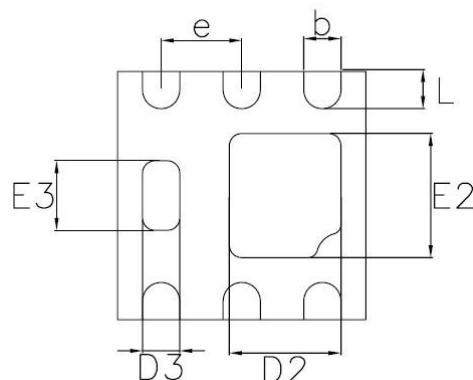


Packaging Information



Top View

Side View



Bottom View

Symbol	Dimensions in millimeter		
	Min	Typ	Max
A	0.70	0.75	0.80
A1	0.00	-	0.05
A3	0.203 Ref.		
D	1.95	2.00	2.05
E	1.95	2.00	2.05
D2	0.85	0.90	0.95
E2	0.75	0.80	0.85
D3	0.25	0.30	0.35
E3	0.51	0.56	0.61
b	0.25	0.30	0.35
L	0.30	0.35	0.40
e	0.65 BSC.		

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by LOWPOWER manufacturer:

Other Similar products are found below :

[614233C](#) [648584F](#) [MCH3443-TL-E](#) [MCH6422-TL-E](#) [FDPF9N50NZ](#) [FW216A-TL-2W](#) [FW231A-TL-E](#) [APT5010JVR](#) [NTNS3A92PZT5G](#)
[IRF100S201](#) [JANTX2N5237](#) [2SK2464-TL-E](#) [2SK3818-DL-E](#) [FCA20N60_F109](#) [FDZ595PZ](#) [STD6600NT4G](#) [FSS804-TL-E](#) [2SJ277-DL-E](#)
[2SK1691-DL-E](#) [2SK2545\(Q,T\)](#) [D2294UK](#) [405094E](#) [423220D](#) [MCH6646-TL-E](#) [TPCC8103,L1Q\(CM](#) [367-8430-0972-503](#) [VN1206L](#)
[424134F](#) [026935X](#) [051075F](#) [SBVS138LT1G](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [751625C](#) [873612G](#) [IRF7380TRHR](#)
[IPS70R2K0CEAKMA1](#) [RJK60S3DPP-E0#T2](#) [RJK60S5DPK-M0#T0](#) [APT5010JVFR](#) [APT12031JFLL](#) [APT12040JVR](#) [DMN3404LQ-7](#)
[NTE6400](#) [JANTX2N6796U](#) [JANTX2N6784U](#) [JANTXV2N5416U4](#) [SQM110N05-06L-GE3](#) [SIHF35N60E-GE3](#)